DATA SHEET

SKY67106-306LF: 1.5-3.0 GHz Two-Stage, High Linearity and High Gain Low-Noise Amplifier

Applications

- CDMA, WCDMA, TD-SCDMA, WiMAX, and LTE cellular infrastructure systems
- Ultra low-noise, high gain and high linearity systems

Features

- Ultra-low NF: 0.65 dB @ 1950 MHz
- High gain: 35 dB @ 1950 MHz
- Low quiescent current: 100 mA
- Stage 1 adjustable gain and current
- Wideband performance, useable to 3 GHz
- Small, QFN (16-pin, 4 x 4 mm) Pb-free package (MSL1, 260 °C per JEDEC J-STD-020)

Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.

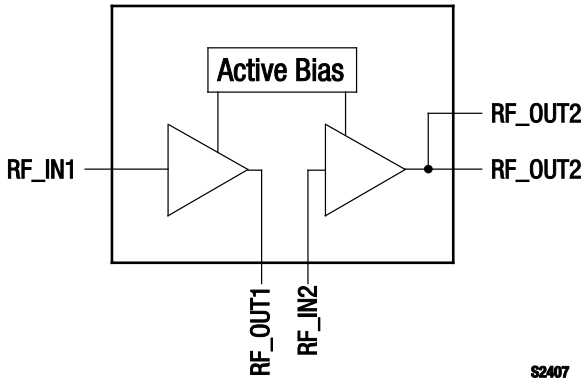


Figure 1. SKY67106-306LF Block Diagram

Description

The SKY67106-306LF is a GaAs pHEMT and HBT two-stage, Low-Noise Amplifier (LNA) with active bias and high linearity performance. The pHEMT front end of the device provides an ultra-low Noise Figure (NF) while the HBT output stage provides high gain, linearity, and efficiency.

The SKY67106-306LF operates in the frequency range of 1.5 to 3.0 GHz. For lower frequency operation, the pin and layout-compatible SKY67105-306LF (Data Sheet document # 201518) should be used.

The SKY67106-306LF is provided in a 4 x 4 mm, 16-pin Quad Flat No-Lead (QFN) package. A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

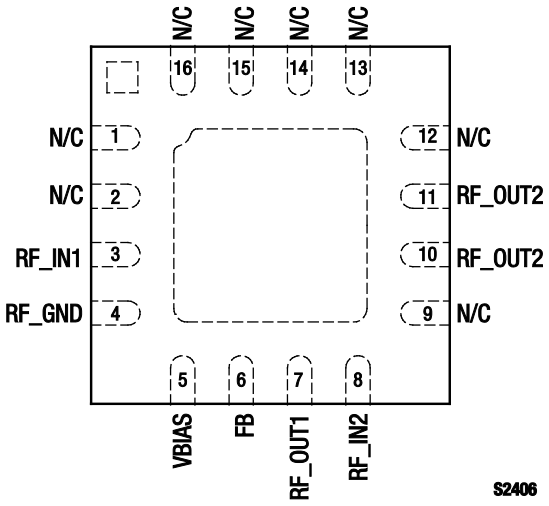


Figure 2. SKY67106-306LF Pinout – 16-Pin QFN (Top View)

Table 1. SKY67106-306LF Signal Descriptions

Pin #	Name	Description	Pin #	Name	Description
1	N/C	No connection. May be grounded with no change in performance.	9	N/C	No connection. May be grounded with no change in performance.
2	N/C	No connection. May be grounded with no change in performance.	10	RF_OUT2	RF output of second stage amplifier
3	RF_IN1	RF input to first stage amplifier	11	RF_OUT2	RF output of second stage amplifier
4	RF_GND	RF ground for first stage amplifier	12	N/C	No connection. May be grounded with no change in performance.
5	VBIAS	Bias for first stage amplifier. External resistor sets current consumption.	13	N/C	No connection. May be grounded with no change in performance.
6	FB	Feedback pin for first stage amplifer.	14	N/C	No connection. May be grounded with no change in performance.
7	RF_OUT1	RF output of first stage amplifer	15	N/C	No connection. May be grounded with no change in performance.
8	RF_IN2	RF input to second stage amplifier	16	N/C	No connection. May be grounded with no change in performance.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY67106-306LF are provided in Table 2. Eectrical specifications are provided in Table 3 (1950 MHz) and Table 4 (2600 MHz).

Typical performance characteristics of the SKY67106-306LF are illustrated in Figures 3 through 15 (1950 MHz) and in Figures 16 through 28 (2600 MHz).

Table 2. SKY67106-306LF Absolute Maximum Ratings

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	V_{DD}		5.5	V
RF input power	P_{IN}		+15	dBm
Operating temperature	T_{OP}	–40	+85	°C
Storage temperature	T_{STG}	–40	+125	°C
Junction temperature	T_J		+150	°C
Thermal resistance	Θ_{JC}		85	°C/W

Note: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

***CAUTION**: Although this device is designed to be as robust as possible, Electrostatic Discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times. The SKY67106-306LF is a Class 1B ESD device.*

Table 3. SKY67106-306LF Electrical Specifications (Note 1)
(V_{DD} = +5 V, T_{OP} = +25 °C, P_{IN} = –30 dBm, Characteristic Impedance [Z_0] = 50 Ω, Optimized for 1950 MHz Operation, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise Figure	NF	@ 1950 MHz		0.65	0.87	dB
Small signal gain	|S21|	@ 1950 MHz	32.5	35.0		dB
Input return loss	|S11|	@ 1950 MHz	10	14		dB
Output return loss	|S22|	@ 1950 MHz	15	22		dB
Reverse isolation	|S12|	@ 1950 MHz	50	55		dB
3rd Order Input Intercept Point	IIP3	@ 1950 MHz, Δf = 1 MHz, P_{IN} = –30 dBm/tone	0	+2.5		dBm
3rd Order Output Intercept Point	OIP3	@ 1950 MHz, Δf = 1 MHz, P_{IN} = –30 dBm/tone	+34.5	+37.0		dBm
1 dB Input Compression Point	IP1dB	@ 1950 MHz	–11	–9		dBm
1 dB Output Compression Point	OP1dB	@ 1950 MHz	+22	+24		dBm
DC Specifications						
Supply voltage	V_{DD}		3.5	5.0	5.5	V
Quiescent current	I_{DD}	Set with external resistor		100	125	mA
Supply current @ IP1dB	I_{DD_P1DB}	Set with external resistor		160	190	mA

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Typical Performance Characteristics (1950 MHz)

(V_{DD} = +5 V, T_{OP} = +25 °C, P_{IN} = –30 dBm, Characteristic Impedance [Z_0] = 50 Ω, Optimized for 1950 MHz Operation, Unless Otherwise Noted)

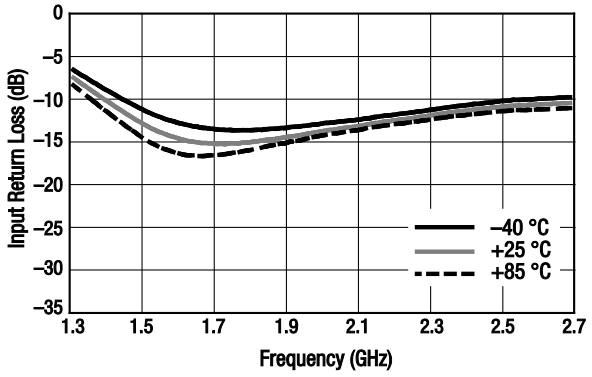


Figure 3. Input Return Loss vs Frequency Over Temperature, Narrow Band

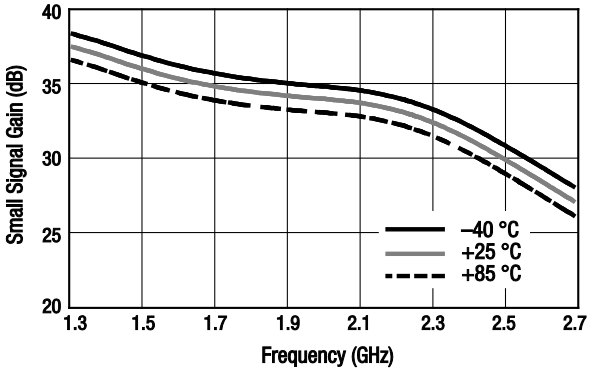


Figure 4. Small Signal Gain vs Frequency Over Temperature, Narrow Band

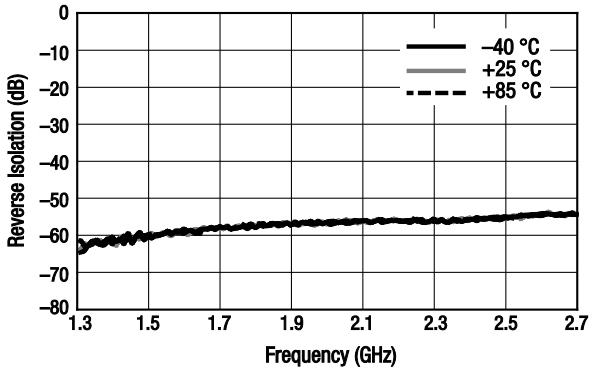


Figure 5. Reverse Isolation vs Frequency Over Temperature, Narrow Band

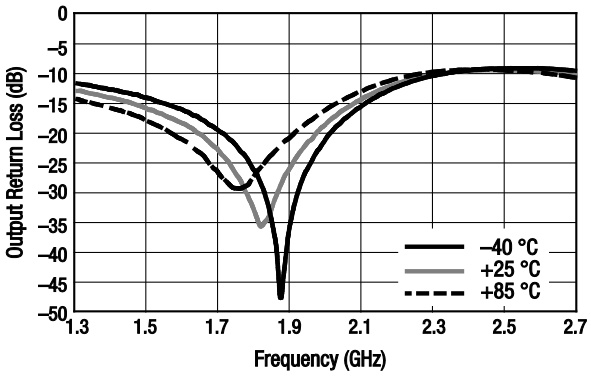


Figure 6. Output Return Loss vs Frequency Over Temperature, Narrow Band

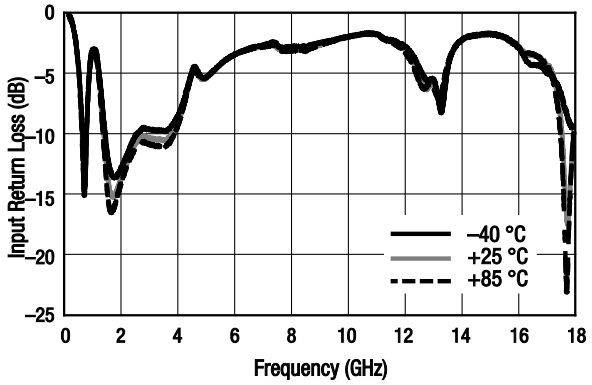


Figure 7. Input Return Loss vs Frequency Over Temperature, Wide Band

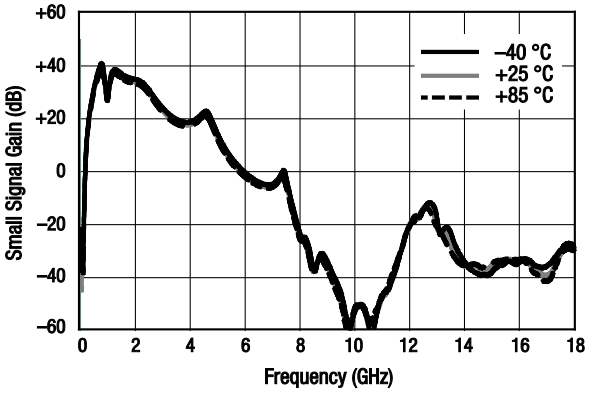


Figure 8. Small Signal Gain vs Frequency Over Temperature, Wide Band

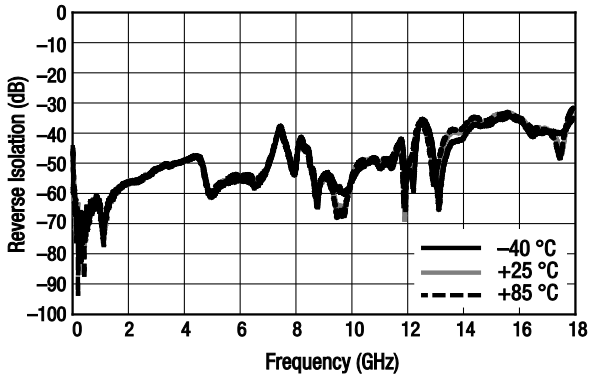


Figure 9. Reverse Isolation vs Frequency Over Temperature, Wide Band

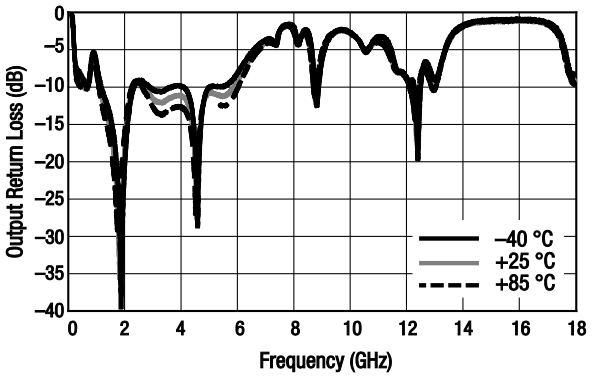


Figure 10. Output Return Loss vs Frequency Over Temperature, Wide Band

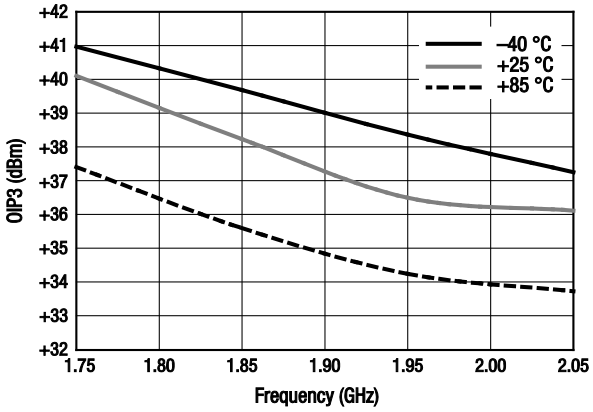


Figure 11. OIP3 vs Frequency Over Temperature

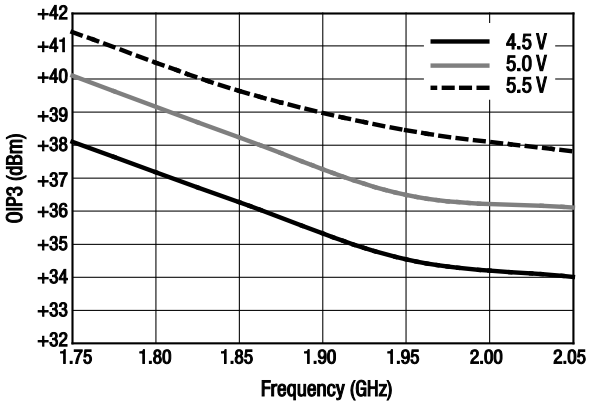


Figure 12. OIP3 vs Frequency Over Voltage

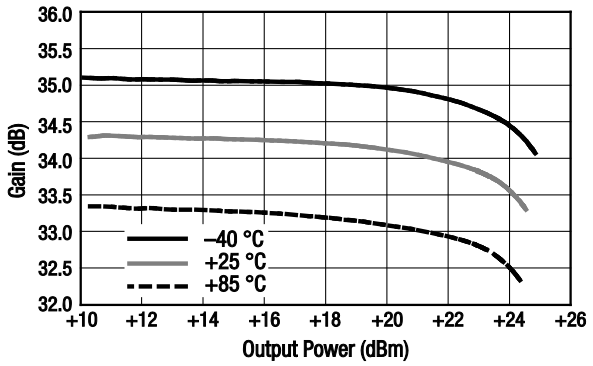


Figure 13. Gain vs Output Power Over Temperature

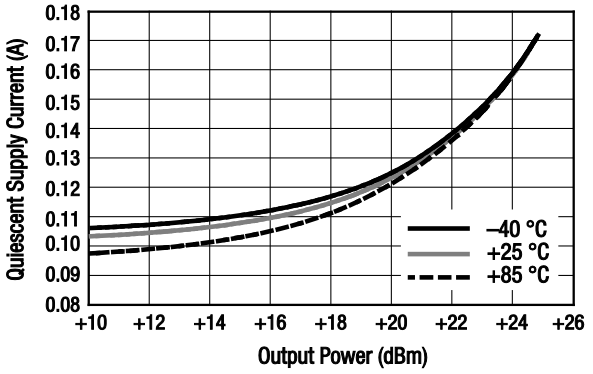


Figure 14. Quiescent Supply Current vs Output Power Over Temperature

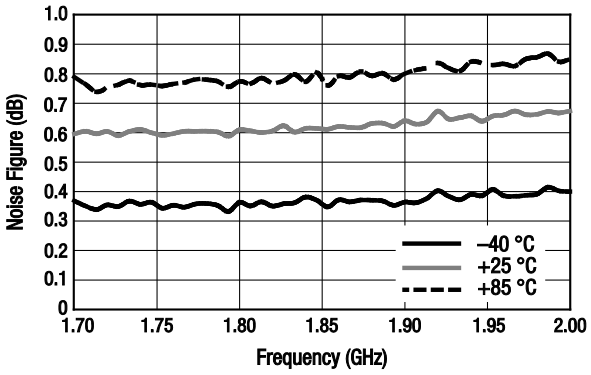


Figure 15. Noise Figure vs Frequency Over Temperature

Table 4. SKY67106-306LF Electrical Specifications (Note 1)
(V_{DD} = +5 V, T_{OP} = +25 °C, P_{IN} = –30 dBm, Characteristic Impedance [Z_0] = 50 Ω, Optimized for 2600 MHz Operation, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
RF Specifications						
Noise Figure	NF	@ 2600 MHz		0.92	1.10	dB
Small signal gain	$\|S_{21}\|$	@ 2600 MHz	28	31		dB
Input return loss	$\|S_{11}\|$	@ 2600 MHz	8	10		dB
Output return loss	$\|S_{22}\|$	@ 2600 MHz	18	30		dB
Reverse isolation	$\|S_{12}\|$	@ 2600 MHz	48	53		dB
3rd Order Input Intercept Point	IIP3	@ 2600 MHz, Δf = 1 MHz, P_{IN} = –30 dBm/tone	+1	+4		dBm
3rd Order Output Intercept Point	OIP3	@ 2600 MHz, Δf = 1 MHz, P_{IN} = –30 dBm/tone	+32	+35		dBm
1 dB Input Compression Point	IP1dB	@ 2600 MHz	–9.5	–7		dBm
1 dB Output Compression Point	OP1dB	@ 2600 MHz	+21.5	+24		dBm
DC Specifications						
Supply voltage	V_{DD}		3.5	5.0	5.5	V
Quiescent current	I_{DD}	Set with external resistor		98	125	mA
Supply current @ IP1dB	I_{DD_P1DB}	Set with external resistor		160	190	mA

Note 1: Performance is guaranteed only under the conditions listed in this Table.

Typical Performance Characteristics (2600 MHz)

(V_{DD} = +5 V, T_{OP} = +25 °C, P_{IN} = –30 dBm, Characteristic Impedance [Z_0] = 50 Ω, Optimized for 2600 MHz Operation, Unless Otherwise Noted)

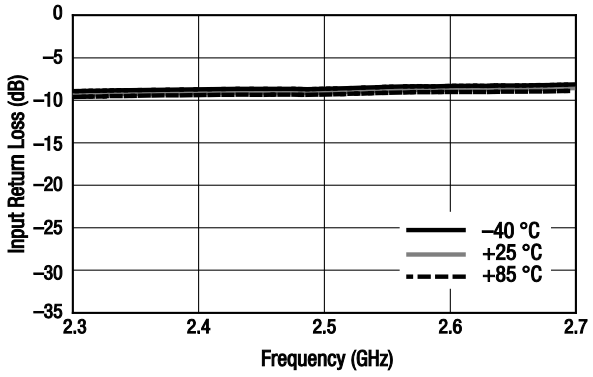


Figure 16. Input Return Loss vs Frequency Over Temperature, Narrow Band

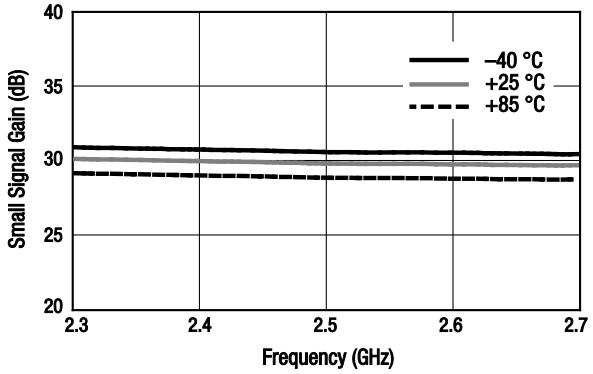


Figure 17. Small Signal Gain vs Frequency Over Temperature, Narrow Band

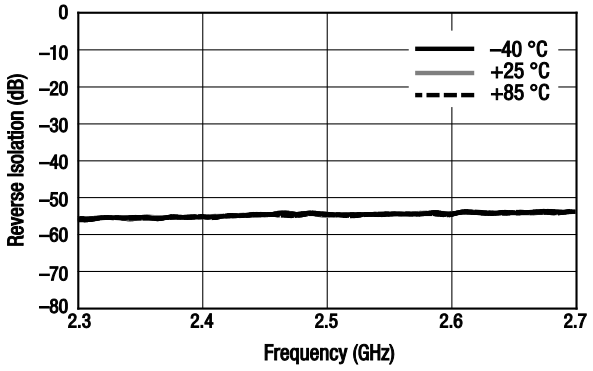


Figure 18. Reverse Isolation vs Frequency Over Temperature, Narrow Band

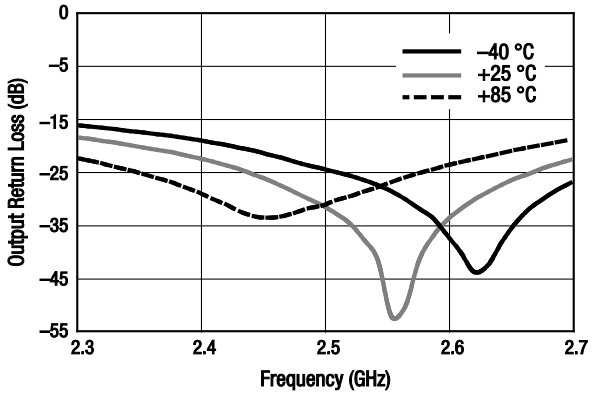


Figure 19. Output Return Loss vs Frequency Over Temperature, Narrow Band

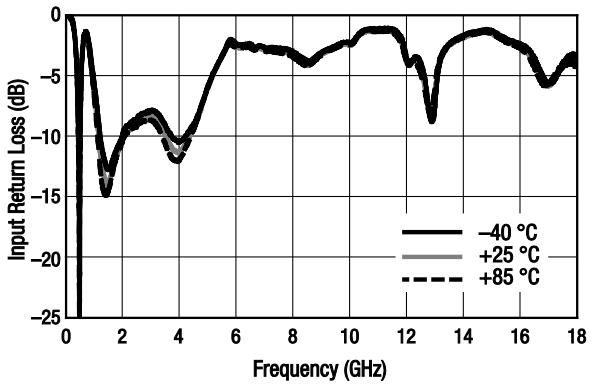


Figure 20. Input Return Loss vs Frequency Over Temperature, Wide Band

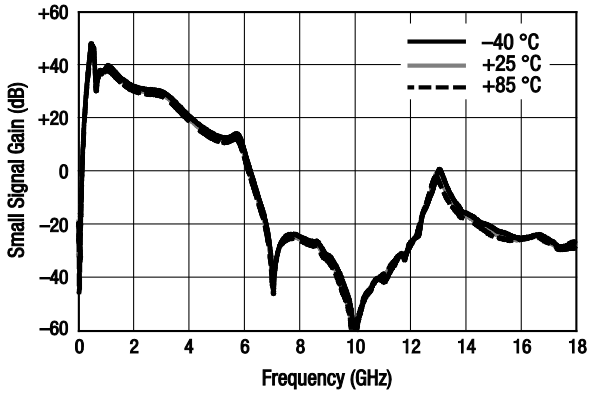


Figure 21. Small Signal Gain vs Frequency Over Temperature, Wide Band

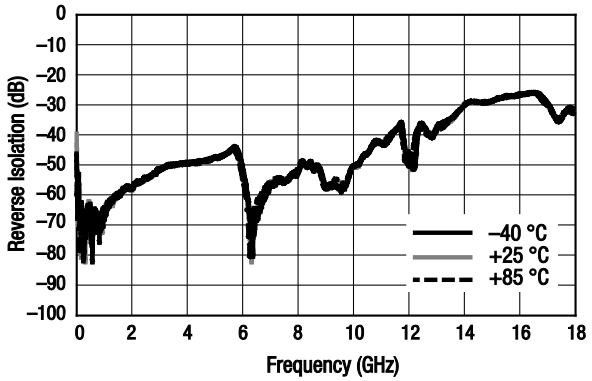


Figure 22. Reverse Isolation vs Frequency Over Temperature, Wide Band

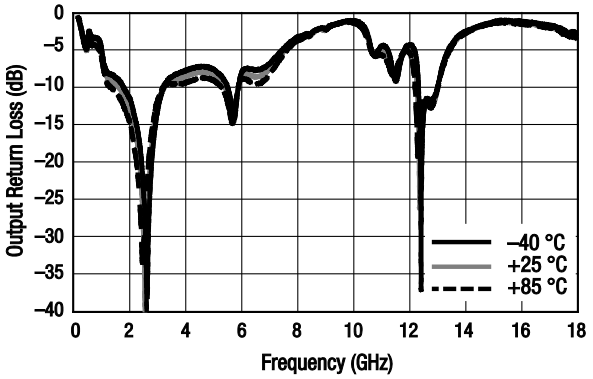


Figure 23. Output Return Loss vs Frequency Over Temperature, Wide Band

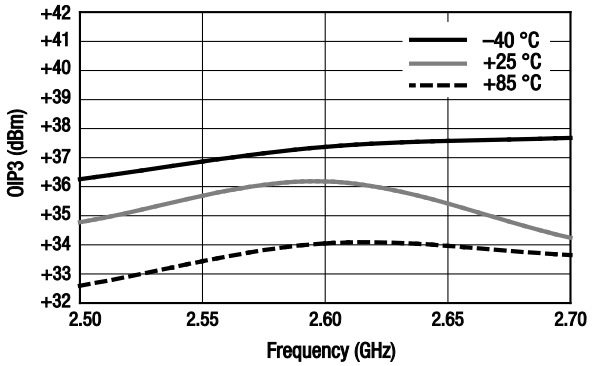


Figure 24. OIP3 vs Frequency Over Temperature

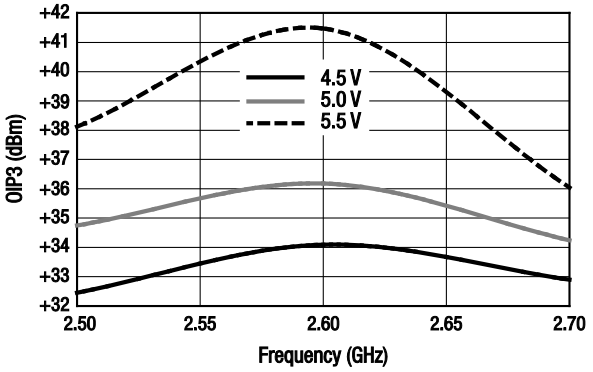


Figure 25. OIP3 vs Frequency Over Voltage

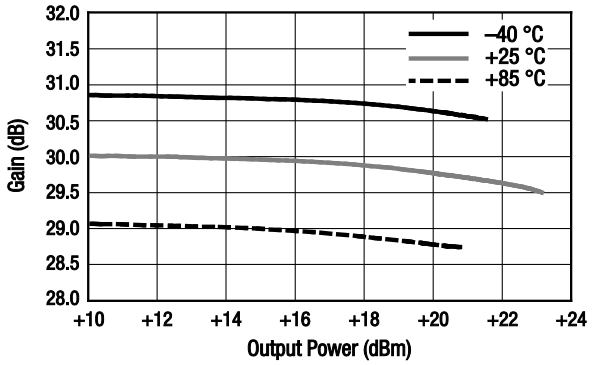


Figure 26. Gain vs Output Power Over Temperature

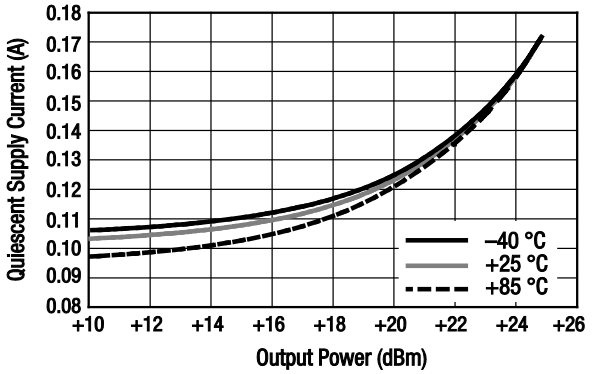


Figure 27. Quiescent Supply Current vs Output Power Over Temperature

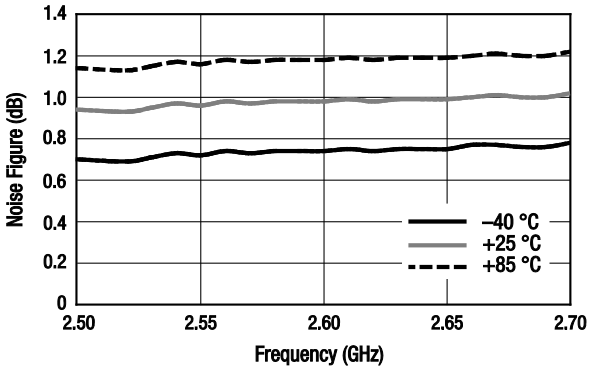


Figure 28. Noise Figure vs Frequency Over Temperature

Evaluation Board Description

The SKY67106-306LF Evaluation Board is used to test the performance of the SKY67106-306LF two-stage LNA. An Evaluation Board schematic diagram is provided in Figure 29 (1950 MHz) and Table 5 provides the Evaluation Board Bill of Materials (1950 MHz).

An Evaluation Board schematic diagram is provided in Figure 30 (2600 MHz) and Table 6 provides the Evaluation Board Bill of Materials (2600 MHz).

Evaluation Board assembly drawings are shown in Figure 31 (1950 MHz) and in Figure 32 (2600 MHz).

This Evaluation Board has many unused pads for components so that it can accommodate tuning over a wide range of frequencies. Refer to the relevant assembly diagram, schematic, and Bill of Materials for the correct component values and placements for a particular operating frequency.

Note that the VDD3 pin on the Evaluation Board does not need to be connected and should be left open.

Package Dimensions

The PCB layout footprint for the SKY67106-306LF is shown in Figure 33. Typical case markings are noted in Figure 34. Package dimensions for the 16-pin QFN are shown in Figure 35, and tape and reel dimensions are provided in Figure 36.

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

THE SKY67106-306LF is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

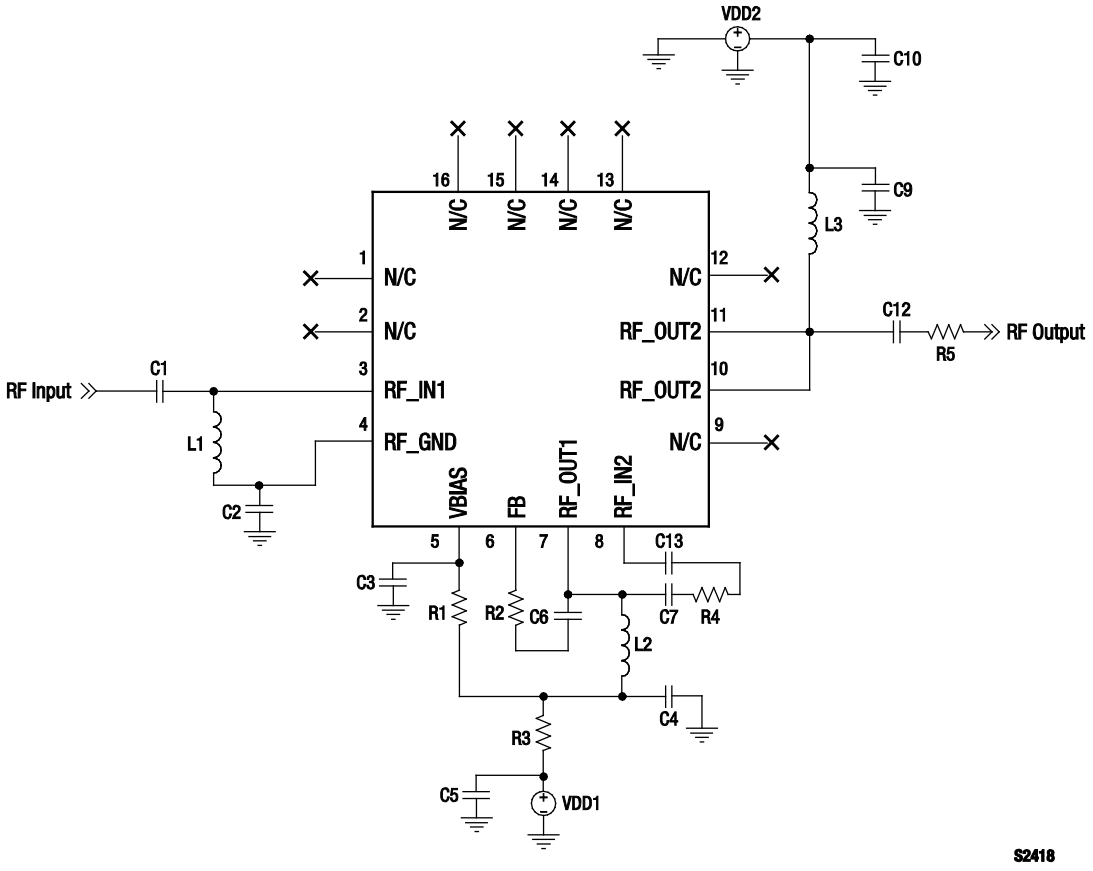


Figure 29. SKY67106-306LF Evaluation Board Schematic (1950 MHz)

Table 5. SKY67106-306LF Evaluation Board Bill of Materials (1950 MHz)

Component	Value	Size	Manufacturer	Manufacturer Part Number
C1	18 pF	0402	Murata GJM	
C2	9 pF	0402	Murata GJM	
C3	0.1 µF	0402	Murata GRM	
C6, C9	2.7 pF	0402	Murata GRM	
C7	3.9 pF	0402	Murata GRM	
C4	10000 pF	0402	Murata GRM	
C5	1000 pF	0402	Murata GRM	
C10	100 pF	0402	Murata GRM	
C12	12 pF	0402	Murata GRM	
C13	22 pF	0402	Murata GRM	
L1	4.3 nH	0402	Coilcraft HP	
L2	3.3 nH	0402	TDK MLG	
L3	27 nH	0402	TDK MLG	
R1	2 kΩ	0402	Panasonic 1%	
R2	200 Ω	0402	Panasonic 1%	
R3, R4, R5	0 Ω	0402	Panasonic	

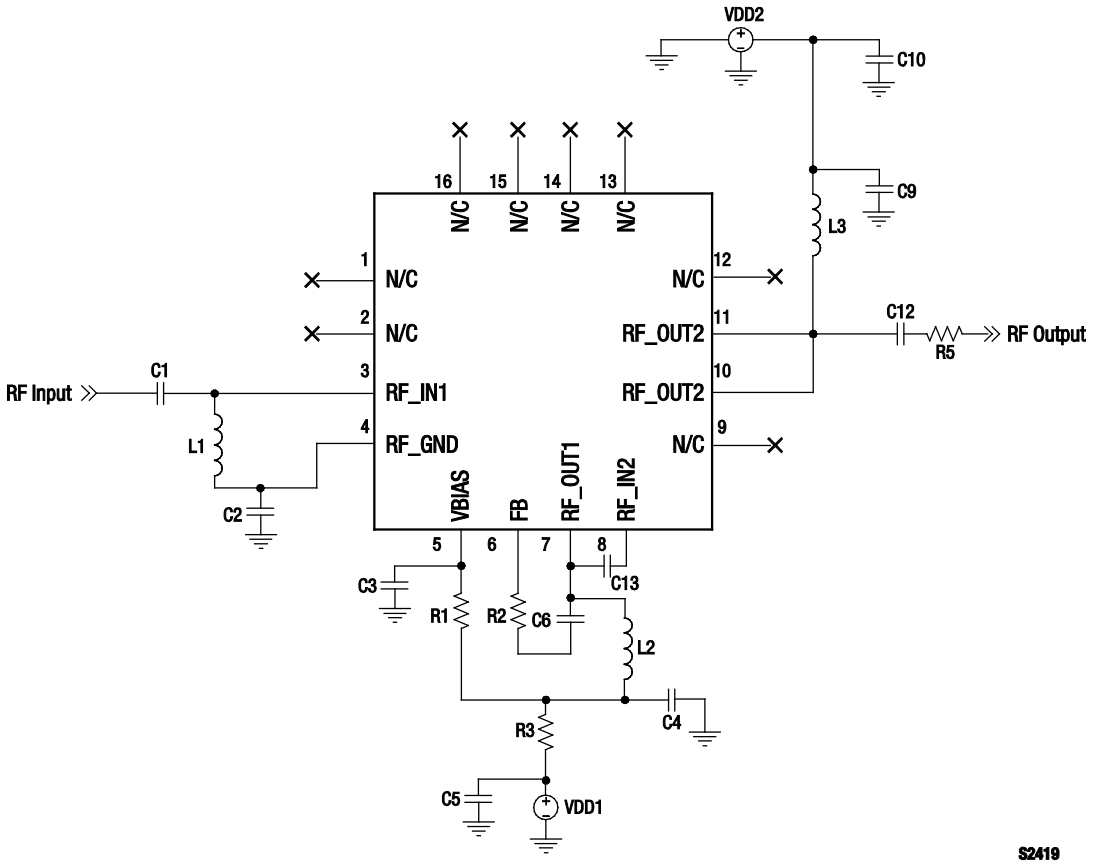
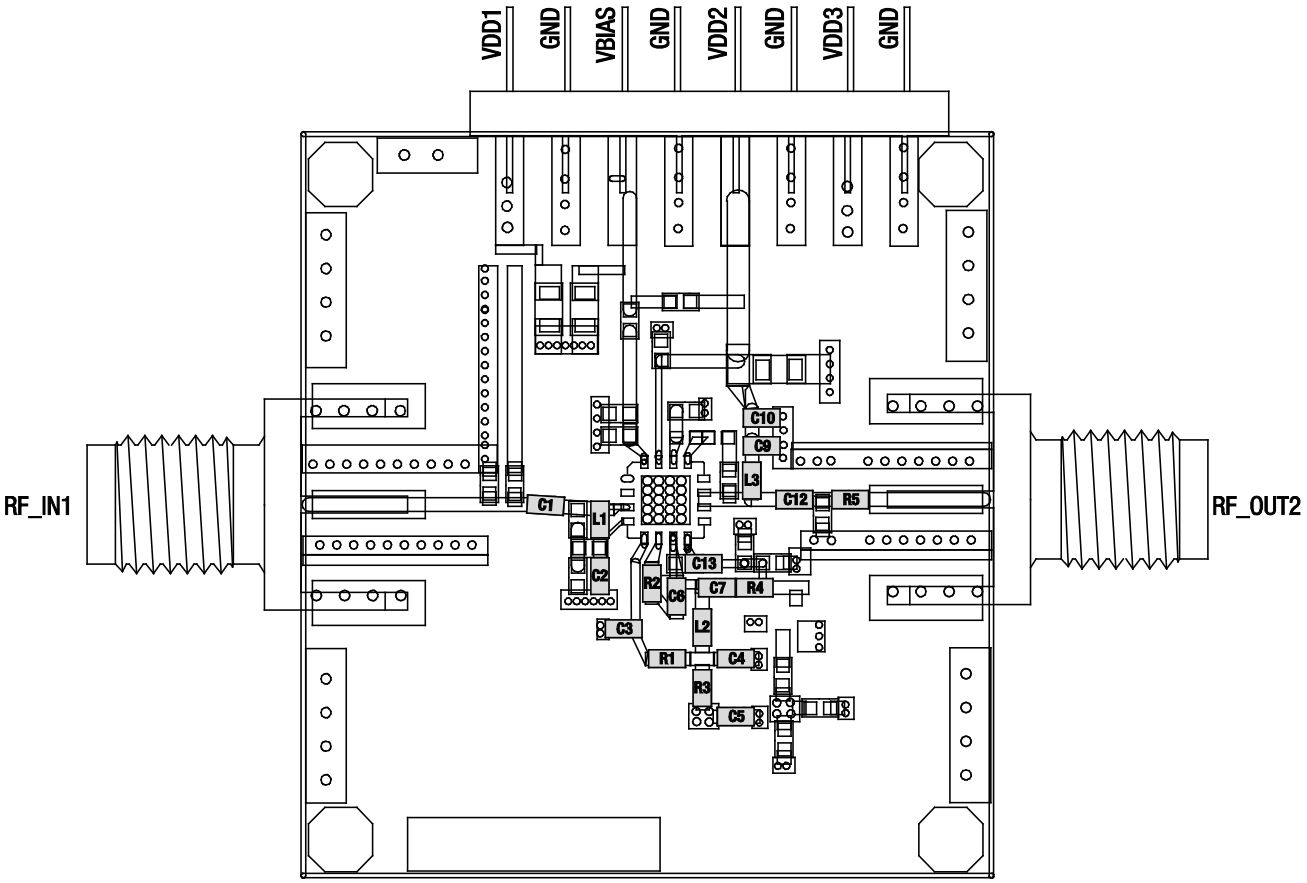


Figure 30. SKY67106-306LF Evaluation Board Schematic (2600 MHz)

Table 6. SKY67106-306LF Evaluation Board Bill of Materials (2600 MHz)

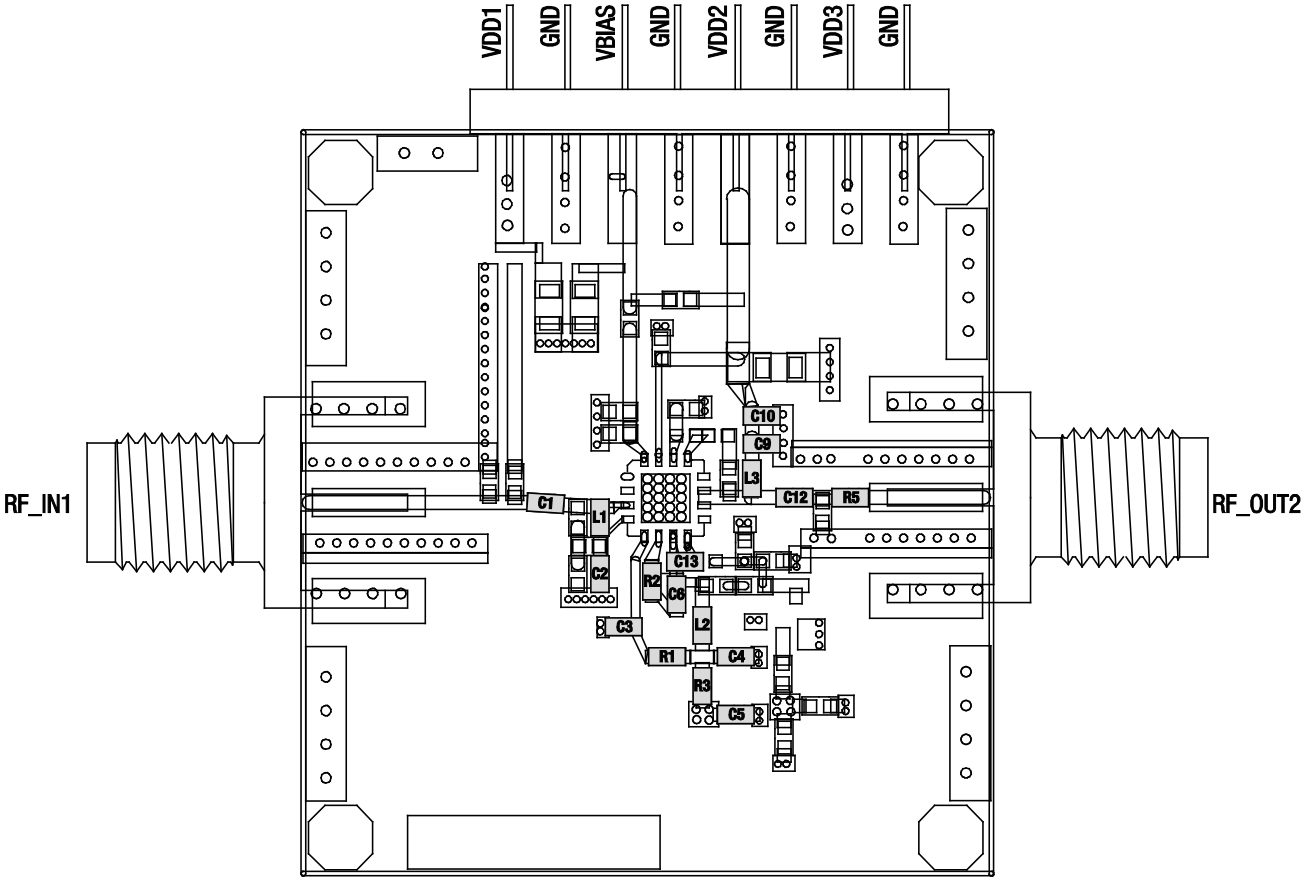
Component	Value	Size	Manufacturer	Manufacturer Part Number
C1	10 pF	0402	Murata GJM	
C2	20 pF	0402	Murata GJM	
C3	0.1 µF	0402	Murata GRM	
C6, C9	2.7 pF	0402	Murata GRM	
C4	10000 pF	0402	Murata GRM	
C5, C10	1000 pF	0402	Murata GRM	
C12	39 pF	0402	Murata GRM	
C13	15 pF	0402	Murata GRM	
L1	5.1 nH	0402	Coilcraft CS	
L2	3.3 nH	0402	TDK MLG	
L3	10 nH	0402	TDK MLG	
R1	2 kΩ	0402	Panasonic 1%	
R2	200 Ω	0402	Panasonic 1%	
R3, R5	0 Ω	0402	Panasonic	



Note: The VDD3 pin should be left unconnected.

S2503

Figure 31. SKY67106-306LF Evaluation Board Assembly Diagram (1950 MHz)



Note: The VDD3 pin should be left unconnected.

S2504

Figure 32. SKY67106-306LF Evaluation Board Assembly Diagram (2600 MHz)

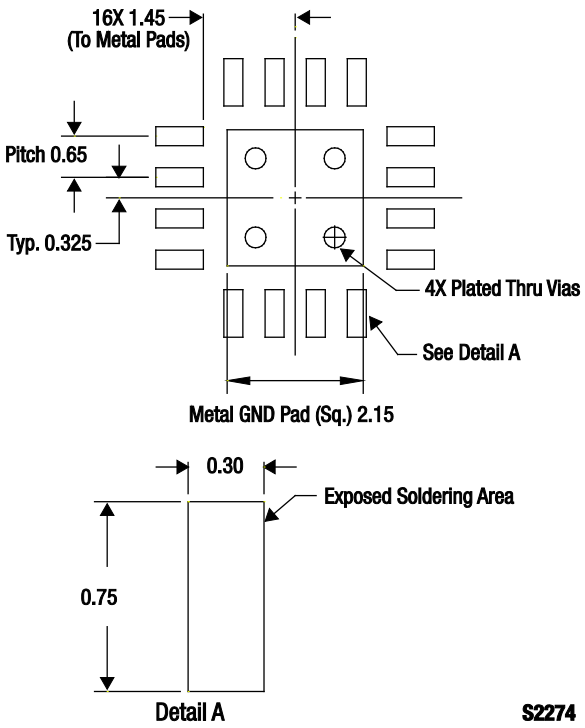


Figure 33. SKY67106-306LF PCB Layout Footprint

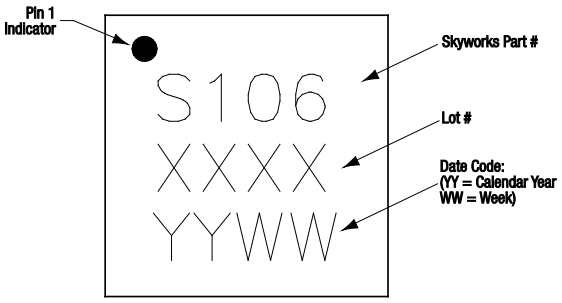
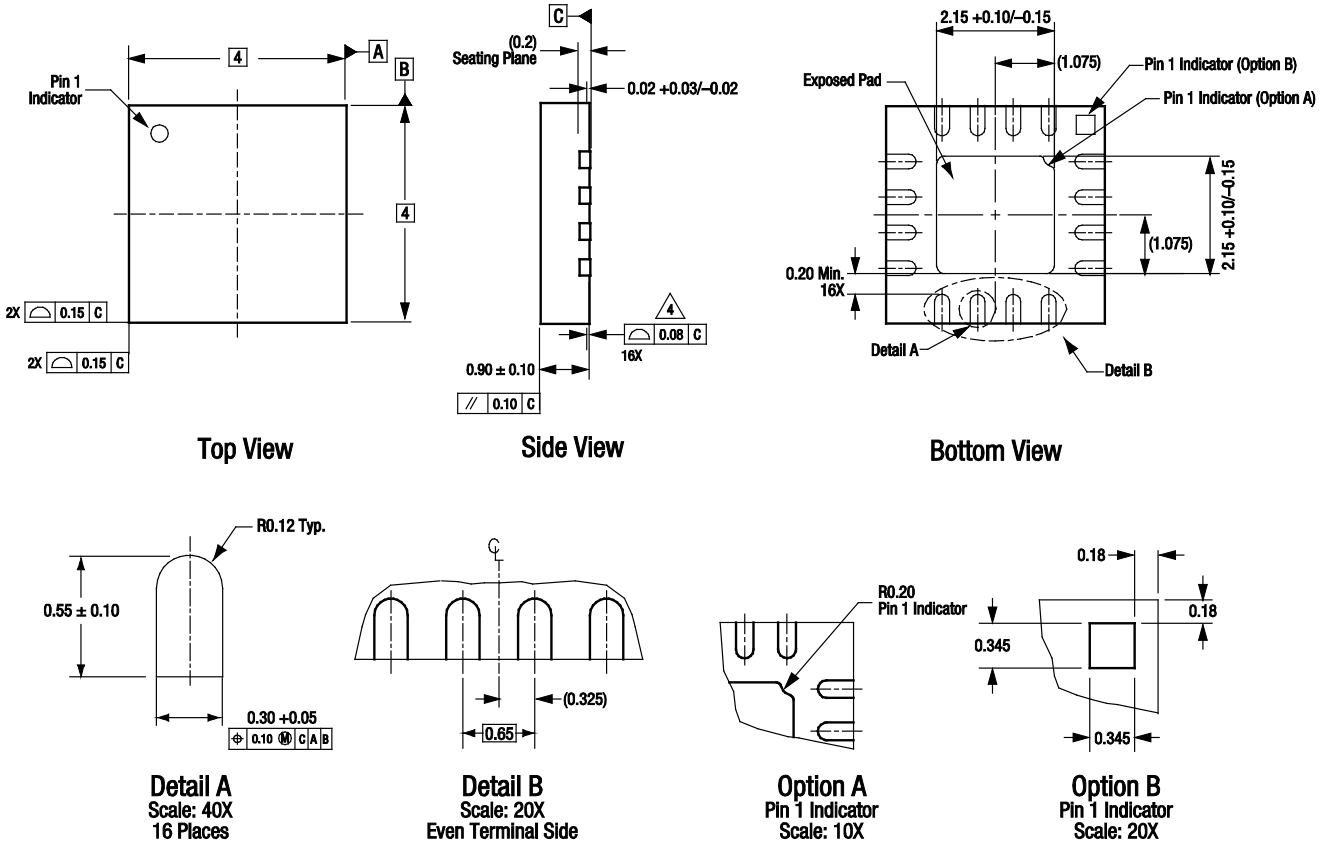


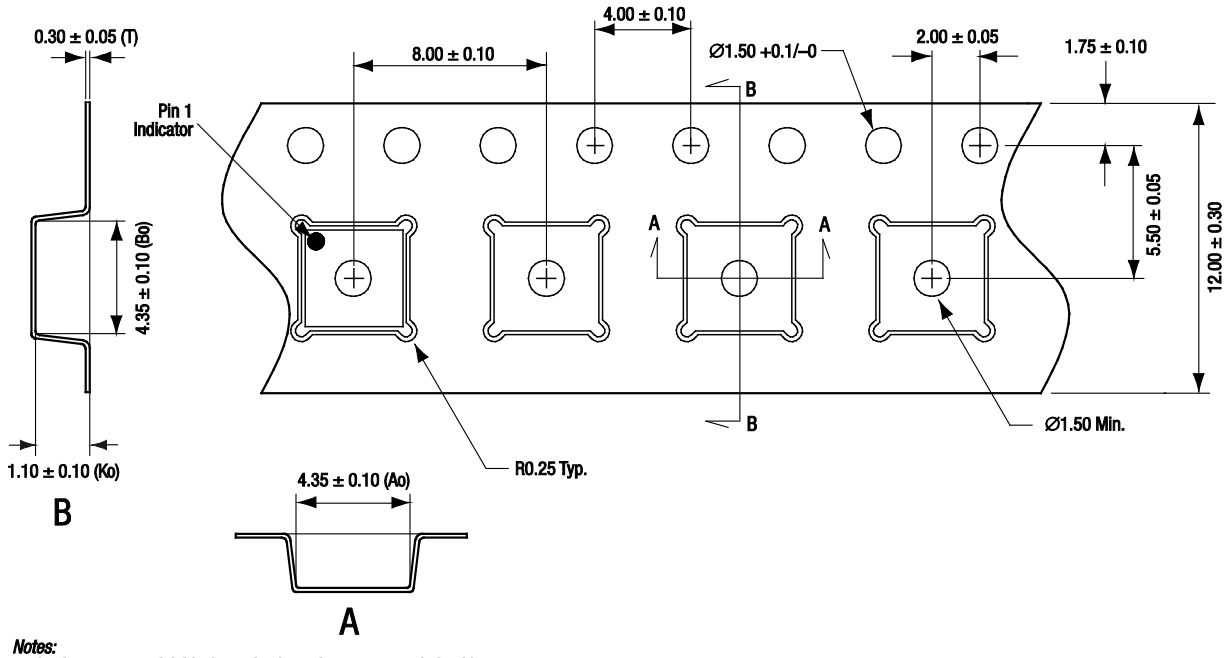
Figure 34. Typical Case Markings



All measurements are in millimeters.
Dimensioning and tolerancing according to ASME Y14.5M-1994.
Coplanarity applies to the exposed heat sink slug as well as the terminals.
Package may have option A or option B pin 1 indicator.

S2400

Figure 35. SKY67106-306LF 16-Pin QFN Package Dimensions



Notes:
1. *Carrier tape material: black conductive polystyrene, non-bakeable*
2. *Cover tape material: transparent conductive HSA*
3. *Cover tape size: 9.2 mm width*
4. *ESD surface resistivity is ≥1 x 10^5 ~ ≤ 1 x 10^{10} Ohms/square per EIA, JEDEC TNR Specification.*
5. *All measurements are in millimeters*

S1846

Figure 36. SKY67106-306LF Tape and Reel Dimensions

Ordering Information

Model Name	Manufacturing Part Number	Evaluation Board Part Number
SKY67106-306LF Two-Stage LNA	SKY67106-306LF	SKY67106-306LF-EVB

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